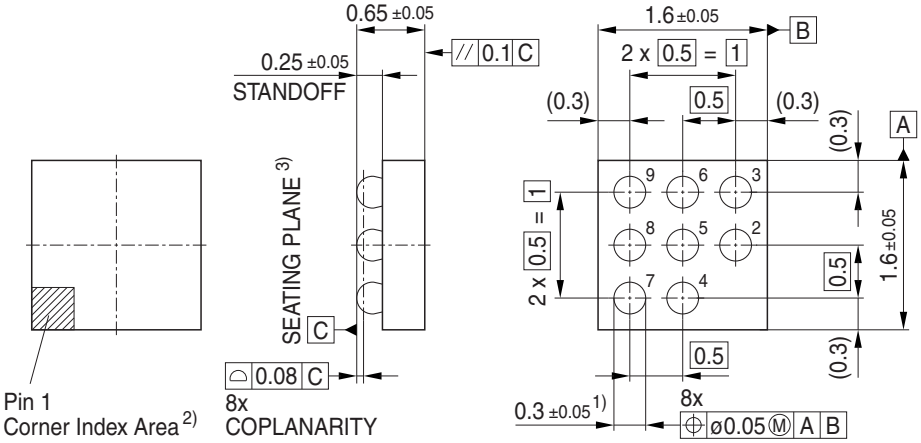
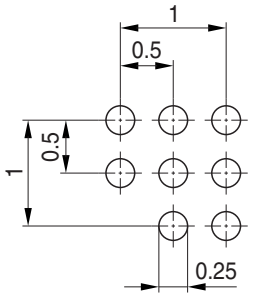
Package Outline



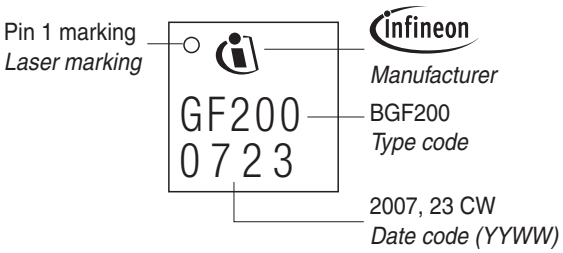
1) Dimension is measured at the maximum solder ball diameter, parallel to primary datum C
2) Pin 1 corner identified by marking
3) Primary datum C and seating plane are defined by the spherical crowns of the balls

Foot Print

Soldering Type: Reflow Soldering

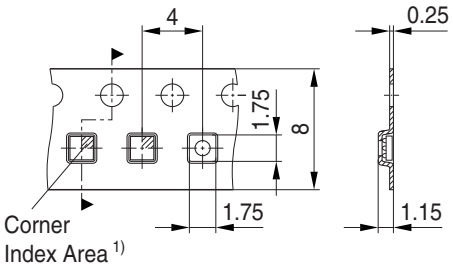


Marking Layout (Example)



Tape and Reel

Reel ø180 mm: 3.000 Pieces/Reel
Reel/Box: 1



1) Balls face down